



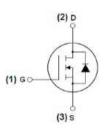
MJ N-Channel Enhancement Mode Power MOSFET

Description

The MJ50N03K uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

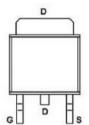
- ♦ V_{DS} =30V,I_D =50A R_{DS(ON)} <8mΩ @ V_{GS}=10V R_{DS(ON)} <12mΩ @ V_{GS}=5V
- ◆ High density cell design for ultra low Rdson
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high E_{AS}
- ◆ Excellent package for good heat dissipation
- ◆ Special process technology for high ESD capability



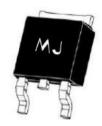


Application

- ◆ Power switching application
- ◆ Hard switched and high frequency circuits
- ◆ Uninterruptible power supply







TO-252-2L top view

100% UIS TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ50N03K	MJ50N03K	TO-252-2L	-	_	-

Absolute Maximum Ratings (Tc =25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	30	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lo	50	А
Drain Current-Continuous(Tc =100℃)	ID(100°C)	35	А
Pulsed Drain Current	IDM	150	А
Maximum Power Dissipation	Po	58	W
Derating factor		0.39	W/°C
Single pulse avalanche energy (Note 5)	Eas	90	mJ
Operating Junction and Storage Temperature Range	Тл ,Тѕтс	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rejc	2.59	°C/W	
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Electrical Characteristics (Tc =25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·					
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =250µA	30	33	-	V
Zero Gate Voltage Drain Current	Ipss	V _{DS} =30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	-					
Gate Threshold Voltage	VGS(th)	V _{DS} =V _{GS} ,I _D =250µA	1.5	2	2.5	V
Durin Course Co. Club Durinton		V _{GS} =10V, I _D =25A	-	6.5	8	mΩ
Drain-Source On-State Resistance	Rds(on)	V _{GS} =5V, I _D =20A	-	8	12	mΩ
Forward Transconductance	grs	V _{DS} =5V,I _D =20A	15	-	-	S
Dynamic Characteristics (Note 4)			1			
Input Capacitance	Clss		-	950	-	PF
Output Capacitance	Coss	V _{DS} =15V,V _{GS} =0V F=1.0MHz	_	280	-	PF
Reverse Transfer Capacitance	Crss	-	-	160	-	PF
Switching Characteristics (Note 4)	'					
Turn-on Delay Time	t _{d(on)}		_	10	-	nS
Turn-on Rise Time	tr	VDD=15V,ID=20A	-	8	-	nS
Turn-Off Delay Time	t _{d(off)}	Vgs=10V,Rgen=1.8Ω	_	30	-	nS
Turn-Off Fall Time	tf		_	5	-	nS
Total Gate Charge	Qg		-	16.6	-	nC
Gate-Source Charge	Qgs	V _{DS} =10V,I _D =20A V _{GS} =10V	_	3.6	-	nC
Gate-Drain Charge	Q _{gd}	-	_	3	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	VsD	V _{GS} =0V,I _S =20A	-	0.85	1.2	V
Diode Forward Current (Note 2)	ls		_	_	50	А
Reverse Recovery Time	trr	TJ=25°C, IF=20A	_	18	-	nS
Reverse Recovery Charge	Qrr	di/dt=100A/µs (Note 3)	_	11	-	nC
Forward Turn-On Time	ton	Intrinsic turn-on time is negligible(turn-on is dominated by LS				

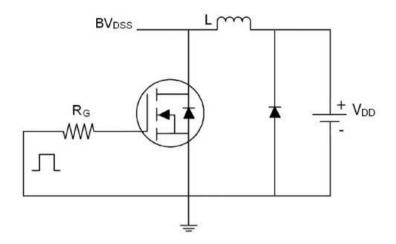
Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4 Guaranteed by design, not subject to production
- (§) EAS condition: Tj=25°C,VDD=15V,VG=10V,L=1mH,Rg=25 Ω

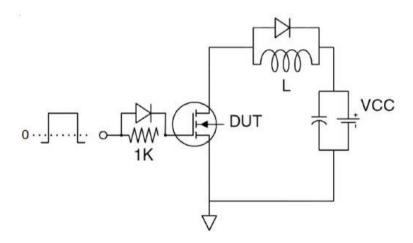




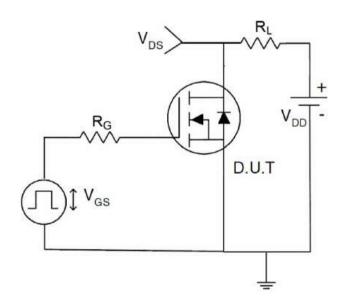
Test circuit



Eas test Circuit



Gate charge test Circuit

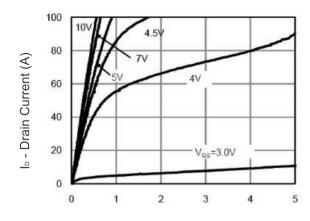


Switch Time Test Circuit

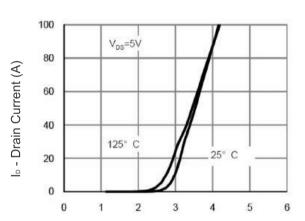




Typical Electrical and Thermal Characteristics (Curves)



Vds Drain-Source Voltage (V)
Figure 1 Output Characteristics



Vgs Gate-Source Voltage (V)
Figure 2 Transfer Characteristics

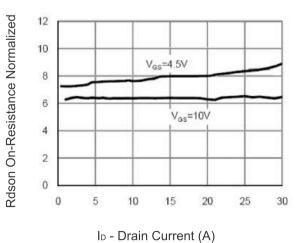
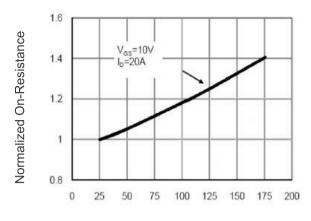
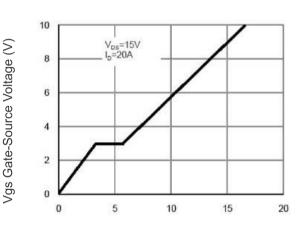


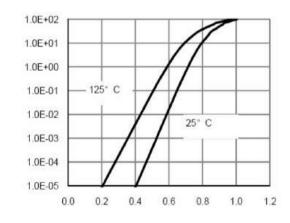
Figure 3 Rdson- Drain Current



TJ -Junction Temperature(°C)
Figure 4 Rdson-Junction Temperature



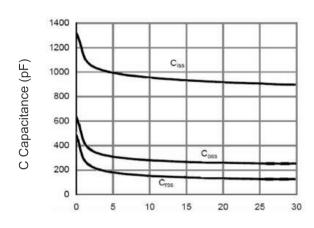
Qg Gate Charge (nC)
Figure 5 Gate Charge



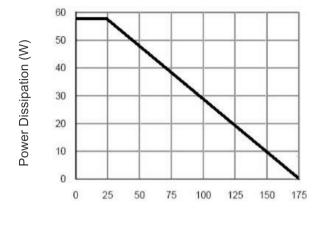
Vsd Source-Drain Voltage (V)
Figure 6 Source- Drain Diode Forward

Is - Reverse Drain Current (A)

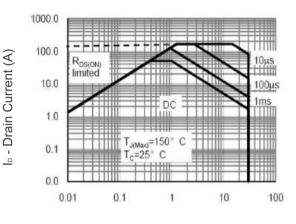




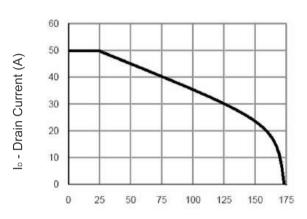
Vds Drain-Source Voltage (V) Figure 7 Capacitance vs Vds



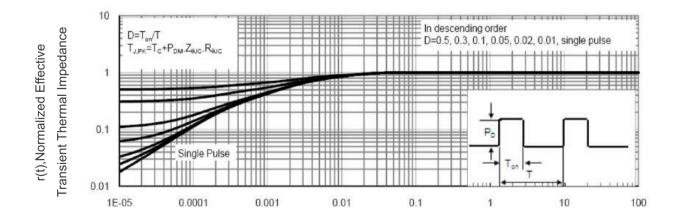
T_J -Junction Temperature(°C) Figure 9 Power De-rating



Vds Drain-Source Voltage (V) Figure 8 Safe Operation Area



 T_J -Junction Temperature(°C) Figure 10 In Current- Junction Temperature



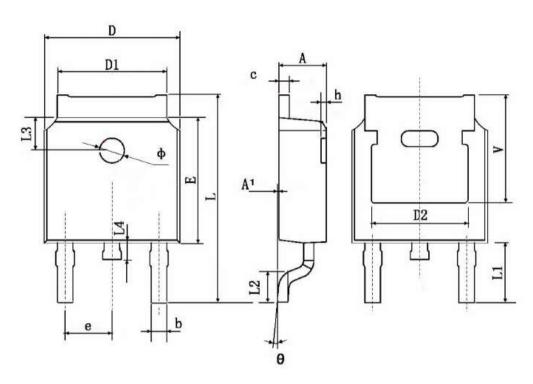
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





TO-252 Package Information



O	Dimensions	n Millimeters	Dimension	s In Inches		
Symbol	Min.	Max.	Min.	Max.		
Α	2.200	2.400	0.087	0.094		
A1	0.000	0.127	0.000	0.005		
b	0.660	0.860	0.026	0.034		
С	0.460	0.580	0.018	0.023		
D	6.500	6.700	0.256	0.264		
D1	5.100	5.460	0.201	0.215		
D2	4.830 TYP.		0.190	TYP.		
E	6.000	6.200	0.236	0.244		
е	2.186	2.386	0.086	0.094		
L	9.800	10.400	0.386	0.409		
L1	2.900	TYP.	0.114	TYP.		
L2	1.400	1.700	0.055	0.067		
L3	1.600	0.063 TYP.		1.600 TYP.		TYP.
L4	0.600	1.000	0.024	0.039		
Ф	1.100	1.300	0.043	0.051		
θ	0°	8°	0.	8°		
h	0.000	0.300	0.000	0.012		
V	5.350	TYP.	0.211	TYP.		





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